

# HSP

### NOTES:

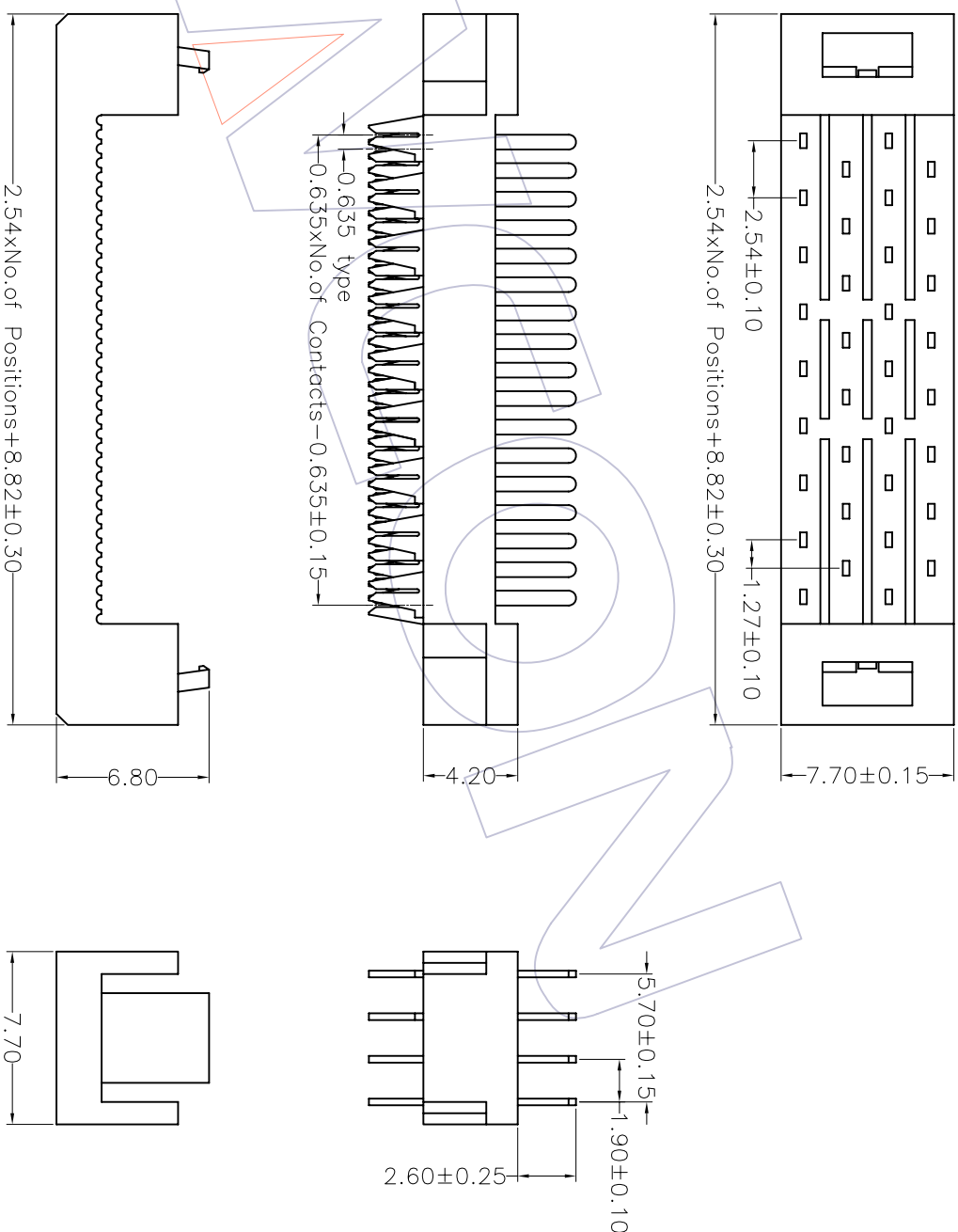
Current Rating:1.0AMP  
 Contact Resistance:20mΩ Max  
 Withstand Voltage:500V AC/DC  
 Insulation Resistance:1000MΩ Min  
 Operation Temperature:-40°C to +105°C

Contact Material:Brass  
 Contact plating:Au or Sn Over Ni  
 Insulator Material:PBt+30%GF(UL94V-0)

## Ordering Information

### 5331-XX B XX B 01

- |             |                  |                 |
|-------------|------------------|-----------------|
| No. of Pins | Contact Plating  | Color Insulator |
| 10 30       | G0=Gold Flash    | B=Black         |
| 14 34       | G1=3u"Gold       | G=Grey(427C)    |
| 16 40       | G2=5u"Gold       | E=Grey(413C)    |
| 18 44       | G3=10u"Gold      |                 |
| 20 50       | G4=15u"Gold      |                 |
| 24 60       | G5=30u"Gold      |                 |
| 26 80       | S0=Gold Flash/Ni |                 |
| 100         | S1=3u"Gold/Ni    |                 |
|             | S2=5u"Gold/Ni    |                 |
|             | S3=10u"Gold/Ni   |                 |
|             | S4=15u"Gold/Ni   |                 |
|             | S5=30u"Gold/Ni   |                 |
|             | SN=Fin           |                 |



OPERATION	DRAW	WEI XD	SCALE	PART NO.
X.X	DESIGN	08/05/26	4:1	
DESIGN	CHECK		UNIT	TITLE:
X.XX	CHECK		mm	
CHECK	APPROVE		SIZE	SHEET
X.XXX	APPROVE		A4	
APPROVE	APPROVE		1/1	Customer NO.
Angle	APPROVE		PROJ.	
± 3'				
DIM	TOL			

**WCON** 维峰五金电子有限公司  
 WAFE HARDWARE ELECTRONICS CO. LTD

5331-XXBXXB01  
 1.27 DIP PLUG CONNECTOR FOUR ROW FOOT  
 (TERMINATED HEIGHT 7.0)

H  
G  
F  
E  
D  
C  
B  
A

H  
G  
F  
E  
D  
C  
B  
A